## BUD42D

## High Speed, High Gain Bipolar NPN Transistor with Antisaturation Network and Transient Voltage Suppression Capability

The BUD42D is a state-of-the-art bipolar transistor. Tight dynamic characteristics and lot to lot minimum spread make it ideally suitable for light ballast applications.

## Features

- Free-Wheeling Diode Built-In
- Flat DC Current Gain
- Fast Switching Times and Tight Distribution
- "6 Sigma" Process Providing Tight and Reproducible Parameter Spreads
- Epoxy Meets UL 94 V-0 @ 0.125 in
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant


## Two Versions

- BUD42D-1: Case 369D for Insertion Mode
- BUD42D, BUD42DT4: Case 369C for Surface Mount Mode

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Collector-Emitter Sustaining Voltage | $\mathrm{V}_{\mathrm{CEO}}$ | 350 | Vdc |
| Collector-Base Breakdown Voltage | $\mathrm{V}_{\mathrm{CBO}}$ | 650 | Vdc |
| Collector-Emitter Breakdown Voltage | $\mathrm{V}_{\mathrm{CES}}$ | 650 | Vdc |
| Emitter-Base Voltage | $\mathrm{V}_{\text {EBO }}$ | 9 | Vdc |
| Collector Current - Continuous | $\mathrm{I}_{\mathrm{C}}$ | 4.0 | Adc |
| Collector Current - Peak (Note 1) | $\mathrm{I}_{\mathrm{CM}}$ | 8.0 | Adc |
| Base Current - Continuous | $\mathrm{I}_{\mathrm{B}}$ | 1.0 | Adc |
| Base Current - Peak (Note 1) | $\mathrm{I}_{\mathrm{BM}}$ | 2.0 | Adc |
| Total Device Dissipation @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 25 | W |
| Derate above 25 ${ }^{\circ} \mathrm{C}$ |  | 0.2 | $\mathrm{~W} /{ }^{\circ} \mathrm{C}$ |
| Operating and Storage Temperature | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | -65 to <br> +150 | ${ }^{\circ} \mathrm{C}$ |
| ESD - Human Body Model | HBM | 3 B | V |
| ESD - Machine Model | MM | C | V |

## TYPICAL GAIN

| Typical Gain @ $\mathrm{I}_{\mathrm{C}}=1 \mathrm{~A}, \mathrm{~V}_{\mathrm{CE}}=2 \mathrm{~V}$ | $\mathrm{~h}_{\mathrm{FE}}$ | 13 | - |
| :--- | :--- | :--- | :--- |
| Typical Gain @ $\mathrm{I}_{\mathrm{C}}=0.3 \mathrm{~A}, \mathrm{~V}_{\mathrm{CE}}=1 \mathrm{~V}$ | $\mathrm{~h}_{\mathrm{FE}}$ | 16 | - |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width $=5.0 \mathrm{~ms}$, Duty Cycle $=10 \% 10$

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## 4 AMPERES 650 VOLTS, 25 WATTS POWER TRANSISTOR



| A | $=$ Assembly Location |
| :--- | :--- |
| Y | $=$ Year |
| WW | $=$ Work Week |
| BUD43D | Device Code |
| G | P Pb-Free Package |

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 10 of this data sheet.

## BUD42D

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Case | $R_{\theta J C}$ | 5.0 |  |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta J A}$ | 71.4 |  |
| Maximum Lead Temperature for Soldering Purposes: $1 / 8$ in from Case for 5 seconds | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

ELECTRICAL CHARACTERISTICS ( $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |

OFF CHARACTERISTICS

| Collector-Emitter Sustaining Voltage$\left(\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~L}=25 \mathrm{mH}\right)$ |  | $\mathrm{V}_{\text {CEO(sus) }}$ | 350 | 430 | - | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Collector-Base Breakdown Voltage } \\ & \text { (ICBO =1 mA) } \end{aligned}$ |  | $\mathrm{V}_{\text {CBO }}$ | 650 | 780 | - | Vdc |
| Emitter-Base Breakdown Voltage $\left(I_{\text {EBO }}=1 \mathrm{~mA}\right)$ |  | $\mathrm{V}_{\text {EBO }}$ | 9.0 | 12 | - | Vdc |
| Collector Cutoff Current $\left(\mathrm{V}_{\mathrm{CE}}=\text { Rated } \mathrm{V}_{\mathrm{CEO}}, \mathrm{I}_{\mathrm{B}}=0\right)$ | @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ | $I_{\text {CEE }}$ |  |  | $\begin{aligned} & 100 \\ & 200 \end{aligned}$ | $\mu \mathrm{Adc}$ |
| Collector Cutoff Current <br> ( $\mathrm{V}_{\mathrm{CE}}=$ Rated $\mathrm{V}_{\mathrm{CES}}, \mathrm{V}_{\mathrm{EB}}=0$ ) | @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ | Ices |  |  | $\begin{gathered} 10 \\ 200 \end{gathered}$ | $\mu \mathrm{Adc}$ |
| Emitter-Cutoff Current $\left(\mathrm{V}_{\mathrm{EB}}=9 \mathrm{Vdc}, \mathrm{I}_{\mathrm{C}}=0\right)$ |  | $\mathrm{l}_{\text {ebo }}$ | - | - | 100 | $\mu \mathrm{Adc}$ |

ON CHARACTERISTICS

| Base-Emitter Saturation Voltage ( $\mathrm{I}_{\mathrm{C}}=1 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.2 \mathrm{Adc}$ ) | $\mathrm{V}_{\mathrm{BE} \text { (sat) }}$ | - | 0.85 | 1.2 | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Collector-Emitter Saturation Voltage ( $I_{C}=2 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.5 \mathrm{Adc}$ ) | $\mathrm{V}_{\text {CE(sat) }}$ | - | 0.2 | 1.0 | Vdc |
| DC Current Gain $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=1 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=2 \mathrm{Vdc}\right) \\ & \left(\mathrm{I}_{\mathrm{C}}=2 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=5 \mathrm{Vdc}\right) \end{aligned}$ | $\mathrm{h}_{\text {FE }}$ | $\begin{aligned} & 8.0 \\ & 10 \end{aligned}$ | $\begin{aligned} & 13 \\ & 12 \end{aligned}$ | - | - |

## DIODE CHARACTERISTICS

| Forward Diode Voltage <br> $\left(\mathrm{I}_{\mathrm{EC}}=1.0\right.$ Adc $)$ | $\mathrm{V}_{\mathrm{EC}}$ |  | 0 | V |
| :--- | :---: | :---: | :---: | :---: | :---: |

SWITCHING CHARACTERISTICS: Resistive Load (D.C. $\leq 10 \%$, Pulse Width $=40 \mu \mathrm{~s}$ )

| $\left.\begin{array}{l}\text { Turn-Off Time } \\ \left(I_{C}=1.2 ~ A d c, ~\right. \\ \mathrm{I}_{1}\end{array}=0.4 \mathrm{~A}, \mathrm{I}_{\mathrm{B} 2}=0.1 \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right)$ | $\mathrm{T}_{\text {off }}$ | 4.6 | - |
| :--- | :---: | :---: | :---: |
| Fall Time <br> $\left(\mathrm{I}_{\mathrm{C}}=2.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=\mathrm{I}_{\mathrm{B} 2}=0.5 \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=150 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=-2 \mathrm{~V}\right)$ | $\mathrm{T}_{\mathrm{f}}$ |  | 4.55 |

## DYNAMIC SATURATION VOLTAGE

| Dynamic Saturation Voltage: <br> Determined $1 \mu \mathrm{~s}$ and $3 \mu$ s respectively after rising $\mathrm{I}_{\mathrm{B} 1}$ reaches $90 \%$ of final $l_{B 1}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=400 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{B} 1}=40 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V} \end{aligned}$ | @ 1 us | @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{CE} \text { (dsat) }}$ | - | $\begin{aligned} & 2.8 \\ & 3.2 \end{aligned}$ | - | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | @ $3 \mu \mathrm{~s}$ | @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} 0.75 \\ 1.3 \end{gathered}$ |  |  |
|  |  | @ 1 us | @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ |  | - | $\begin{aligned} & \hline 2.1 \\ & 4.7 \end{aligned}$ |  |  |
|  | $\begin{aligned} & \mathrm{I}_{\mathrm{B} 1}=200 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V} \end{aligned}$ | @ $3 \mu \mathrm{~s}$ | @ $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ <br> @ $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ |  | - | $\begin{gathered} \hline 0.35 \\ 0.6 \end{gathered}$ | - |  |

TYPICAL STATIC CHARACTERISTICS


Figure 1. DC Current Gain @ $\mathrm{V}_{\mathrm{CE}}=1 \mathrm{~V}$


Figure 3. Collector Saturation Region


Figure 5. Collector-Emitter Saturation Voltage


Figure 2. DC Current Gain @ $\mathrm{V}_{\mathrm{CE}}=5 \mathrm{~V}$


Figure 4. Collector-Emitter Saturation Voltage


Figure 6. Collector-Emitter Saturation Voltage

## BUD42D

TYPICAL STATIC CHARACTERISTICS


Figure 7. Base-Emitter Saturation Region


Figure 9. Base-Emitter Saturation Region


Figure 8. Base-Emitter Saturation Region


Figure 10. Forward Diode Voltage


Figure 11. Capacitance


Figure 13. Resistive Switching, $\mathrm{t}_{\mathrm{on}}$


Figure 15. Inductive Storage Time,


Figure 12. $B_{\text {vCER }}=f\left(R_{B E}\right)$


Figure 14. Resistive Switching, $\mathrm{t}_{\text {off }}$


Figure 16. Inductive Storage Time,
$\mathbf{t}_{\text {ci }} @ \mathbf{h t r}_{\text {en }} 10$

TYPICAL SWITCHING CHARACTERISTICS


Figure 17. Inductive Fall and Cross Over Time, $t_{f i}$ and $t_{c} @ h_{\text {FE }}=5$


Figure 19. Inductive Cross Over Time, $\mathbf{t}_{\mathrm{c}} @ \mathrm{~h}_{\mathrm{FE}}=10$


Figure 21. Inductive Fall Time, $\mathbf{t}_{\mathrm{f}}$


Figure 18. Inductive Fall Time,
$\mathbf{t}_{\mathrm{fi}} @ \mathbf{h}_{\mathrm{FE}}=10$


Figure 20. Inductive Storage Time, $\mathbf{t}_{\mathbf{s i}}$


Figure 22. Inductive Cross Over Time, $\mathbf{t}_{\mathbf{c}}$


Figure 23. Inductive Storage Time, $\mathbf{t}_{\mathbf{s i}}$


Figure 25. Dynamic Saturation Voltage Measurements


Figure 24. Forward Recovery Time, $\mathrm{t}_{\mathrm{fr}}$


Figure 26. Inductive Switching Measurements

## BUD42D

## TYPICAL SWITCHING CHARACTERISTICS

Table 1. Inductive Load Switching Drive Circuit


$$
\begin{aligned}
& \mathrm{V}_{\text {(BR) CEO(sus) }} \\
& \mathrm{L}=10 \mathrm{mH} \\
& \mathrm{R}_{\mathrm{B} 2}=\infty \\
& \mathrm{V}_{\mathrm{CC}}=20 \mathrm{Volts} \\
& \mathrm{I}_{\mathrm{C}(\mathrm{pk})}=100 \mathrm{~mA}
\end{aligned}
$$

| Inductive Switching | RBSOA |
| :--- | :--- |
| $L=200 \mu \mathrm{H}$ | $\mathrm{L}=500 \mu \mathrm{H}$ |
| $\mathrm{R}_{\mathrm{B} 2}=0$ | $\mathrm{R}_{\mathrm{B} 2}=0$ |
| $\mathrm{~V}_{\mathrm{CC}}=15$ Volts | $\mathrm{V}_{\mathrm{CC}}=15$ Volts |
| $\mathrm{R}_{\mathrm{B} 1}$ selected for | $\mathrm{R}_{\mathrm{B} 1}$ selected for |
| desired $\mathrm{I}_{\mathrm{B} 1}$ | desired $\mathrm{I}_{\mathrm{B} 1}$ |



Figure 27. $\mathrm{t}_{\mathrm{fr}}$ Measurement

MAXIMUM RATINGS


Figure 28. Forward Bias Safe Operating Area


Figure 29. Reverse Bias Safe Operating Area


Figure 30. Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{C}-V_{C E}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 28 is based on $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} ; \mathrm{T}_{\mathrm{j}(\mathrm{pk})}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to $10 \%$ but must be derated when $\mathrm{T}_{\mathrm{C}}>25^{\circ} \mathrm{C}$. Second Breakdown limitations do not derate like thermal limitations. Allowable current at the voltages shown on

Figure 28 may be found at any case temperature by using the appropriate curve on Figure 30.
$\mathrm{T}_{\mathrm{j}(\mathrm{pk})}$ may be calculated from the data in Figure 31. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base to emitter junction reverse biased. The safe level is specified as reverse biased safe operating area (Figure 29). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.


Figure 31. Thermal Response

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| BUD42D-1G | DPAK <br> Straight Lead <br> (Pb-Free) | 75 Units / Rail |
| BUD42DT4G | DPAK <br> (Pb-Free) | 2500 Units / Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.


SCALE 1:1


IPAK
CASE 369D-01
ISSUE C
DATE 15 DEC 2010


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
2. CONTROLLING DIMENSION: INCH.

|  | INCHES |  | MILLIMETERS |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 0.235 | 0.245 | 5.97 | 6.35 |
| B | 0.250 | 0.265 | 6.35 | 6.73 |
| C | 0.086 | 0.094 | 2.19 | 2.38 |
| D | 0.027 | 0.035 | 0.69 | 0.88 |
| E | 0.018 | 0.023 | 0.46 | 0.58 |
| F | 0.037 | 0.045 | 0.94 |  |
| G | 0.090 BSC |  | 2.29 |  |
| BSC |  |  |  |  |
| H | 0.034 | 0.040 | 0.87 | 1.01 |
| J | 0.018 | 0.023 | 0.46 | 0.58 |
| K | 0.350 | 0.380 | 8.89 | 9.65 |
| R | 0.180 | 0.215 | 4.45 | 5.45 |
| S | 0.025 | 0.040 | 0.63 | 1.01 |
| V | 0.035 | 0.050 | 0.89 | 1.27 |
| Z | 0.155 | --- | 3.93 | --- |

MARKING
DIAGRAMS

| STYLE 1: |  |
| :--- | :--- |
| PIN 1. | BASE |
| 2. | COLLECTOR |
| 3. | EMITTER |
| 4. | COLLECTOR |


| STYLE 2: | STYLE 3: |  |
| ---: | ---: | :--- |
| PIN 1. GATE | PIN 1. ANODE |  |
| 2. DRAIN | 2. CATHODE |  |
| 3. SOURCE | 3. ANODE |  |
| 4. DRAIN | 4. CATHODE |  |
|  |  |  |
| STYLE 6: | STYLE 7: |  |
| PIN 1. MT1 | PIN 1. | GATE |
| 2. MT2 | 2. | COLLECTOR |
| 3. GATE | 3. EMITTER |  |
| 4. MT2 | 4. | COLIECTOR |



| xxxxxxxxx | $=$ Device Code |
| :--- | :--- |
| A | $=$ Assembly Location |
| IL | = Wafer Lot |
| Y | Y Year |
| WW | Work Week |


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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | IPAK (DPAK INSERTION MOUNT) | PAGE 1 OF 1 |

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DPAK (SINGLE GAUGE)
CASE 369C
ISSUE F
DATE 21 JUL 2015

SCALE 1:1


## SOLDERING FOOTPRINT*



| A | $=$ Assembly Location |
| :--- | :--- |
| L | $=$ Wafer Lot |
| Y | $=$ Year |
| WW | $=$ Work Week |
| G | $=$ Pb-Free Package |

*This information is generic. Please refer to device data sheet for actual part marking.
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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